

Global Wire Wedge Bonder Equipment Market Study 2016-2026, by Segment (Fully Automatic, Semi-automatic,), by Market (Integrated Device Manufacturers (IDMs), Outsourced Semiconductor Assembly and Test (OSAT)), by Company (Kulicke & Soffa, ASM Pacific Technology (ASMPT),)

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Abstracts

SUMMARY

Wedge bonding can be a great solution for performing low profile or fine pitch interconnects and is also well suited for running stitch interconnects (also known as die-to-die bonding and chain bonding), reverse bonding, and ribbon bonding.

The global Wire Wedge Bonder Equipment market will reach Volume Million USD in 2019 and with a CAGR xx% between 2020-2026.

Product Type Coverage (Market Size & Forecast, Major Company of Product Type etc.):

Fully Automatic

Semi-automatic

Manual

Demand Coverage (Market Size & Forecast, Consumer Distribution):

Integrated Device Manufacturers (IDMs)

Outsourced Semiconductor Assembly and Test (OSAT)

Company Coverage (Sales data, Main Products & Services etc.):

Kulicke & Soffa

ASM Pacific Technology (ASMPT)

Hesse

Cho-Onpa

F&K Delvotec Bondtechnik

Palomar Technologies

DIAS Automation

West-Bond

Hybond

TPT

Major Region Market

North America

Europe

Asia-Pacific

South America

Middle East & Africa

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